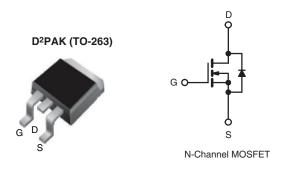
Vishay Siliconix

COMPLIANT HALOGEN

FREE

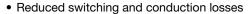
E Series Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} max. at 25 °C (Ω)	0.38			
Q _g max. (nC)	58			
Q _{gs} (nC)	6			
Q _{gd} (nC)	13			
Configuration	Single			



FEATURES

- Low figure-of-merit (FOM) Ron x Qq
- Low input capacitance (Ciss)



- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	D ² PAK (TO-263)
Lead (Pb)-free and Halogen-free	SiHB12N60E-GE3

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)					
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V_{DS}	600	V
Gate-Source Voltage			V_{GS}	± 30	
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$	- I _D	12	
		T _C = 100 °C		7.8	Α
Pulsed Drain Current ^a			I _{DM}	27	
Linear Derating Factor				1.2	W/°C
Single Pulse Avalanche Energy b			E _{AS}	117	mJ
Maximum Power Dissipation			P_{D}	147	W
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C
Drain-Source Voltage Slope T _J = 125 °C		dV/dt	70	1//22	
Reverse Diode dV/dt d			5	- V/ns	
Soldering Recommendations (Peak Temperature) ^c for 10 s				300	°C

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. $V_{DD} = 50 \text{ V}$, starting $T_J = 25 \,^{\circ}\text{C}$, $L = 11.6 \,^{\circ}\text{mH}$, $R_q = 25 \,^{\circ}\Omega$, $I_{AS} = 4.5 \,^{\circ}\text{A}$.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, dl/dt = 100 A/ μ s, starting T_J = 25 °C.



Vishay Siliconix

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W	
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.85	C/ VV	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		-					
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$		600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.71	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2	-	4	V
Cata Caurea Laglaga	I _{GSS}	V _{GS} = ± 20 V		-	-	± 100	nA
Gate-Source Leakage			V _{GS} = ± 30 V	-	-	± 1	μΑ
Zoro Coto Voltago Drain Current		V _{DS} =	V _{DS} = 600 V, V _{GS} = 0 V		-	1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 480 \	/, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 6 A	-	0.32	0.38	Ω
Forward Transconductance	9 _{fs}	V _{DS}	s = 40 V, I _D = 8 A	-	3.8	-	S
Dynamic							
Input Capacitance	C _{iss}		$V_{GS} = 0 V$,	-	937	-	
Output Capacitance	C _{oss}		$V_{DS} = 100 \text{ V},$	-	53	-	
Reverse Transfer Capacitance	C _{rss}	f = 1 MHz		_	5	-	pF
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	41	-	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	136	-	
Total Gate Charge	Q_g	V _{GS} = 10 V I _D = 6 A, V _{DS} = 480 V		-	29	58	
Gate-Source Charge	Q _{gs}			-	6	-	nC
Gate-Drain Charge	Q _{gd}			_	13	-	
Turn-On Delay Time	t _{d(on)}	V _{DD} = 480 V, I _D = 6 A,		-	14	28	
Rise Time	t _r			-	19	38	1
Turn-Off Delay Time	t _{d(off)}	V _{GS} :	= 10 V, $R_g = 9.1 \Omega$	-	35	70	ns
Fall Time	t _f	_ as , g		-	19	38	
Gate Input Resistance	R _g	f = 1 MHz, open drain		-	1.1	-	Ω
Drain-Source Body Diode Characteristic	s						•
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	12	
Pulsed Diode Forward Current	I _{SM}			-	-	48	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 6 A, V _{GS} = 0 V		-	-	1.2	V
Reverse Recovery Time	t _{rr}	1, 20 0, 1, 1, 1, 1, 1, 1, 1, 1, 1, 1, 1, 1, 1,		-	350	-	ns
Reverse Recovery Charge	Q _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = I_S = 6 \text{A},$		-	4	-	μC
Reverse Recovery Current	I _{RRM}	dl/dt = 100 A/μs, V _R = 25 V		_	19	-	A

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .
- b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

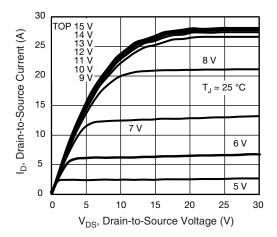


Fig. 1 - Typical Output Characteristics

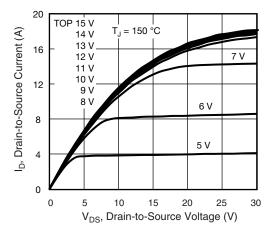


Fig. 2 - Typical Output Characteristics

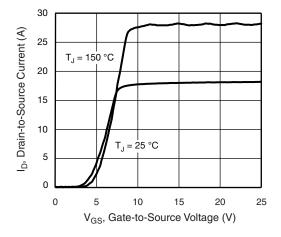


Fig. 3 - Typical Transfer Characteristics

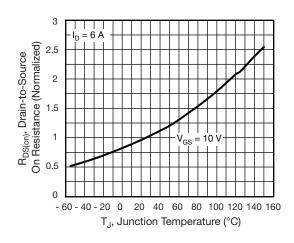


Fig. 4 - Normalized On-Resistance vs. Temperature

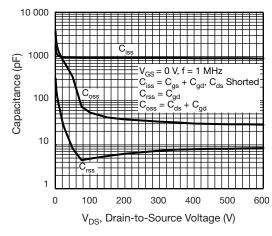


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

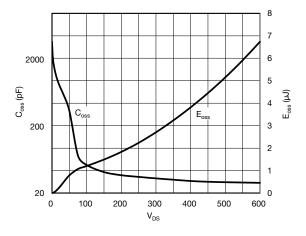


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}



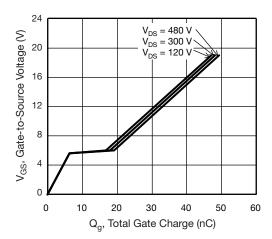


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

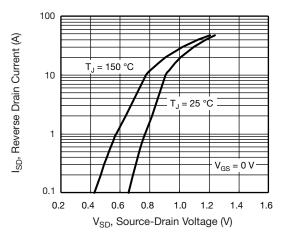


Fig. 8 - Typical Source-Drain Diode Forward Voltage

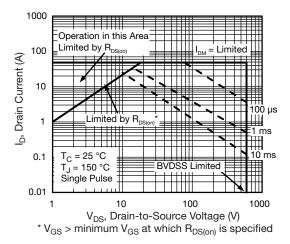


Fig. 9 - Maximum Safe Operating Area

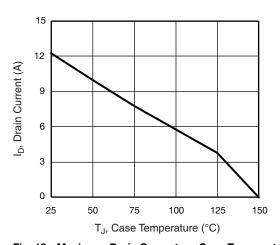


Fig. 10 - Maximum Drain Current vs. Case Temperature

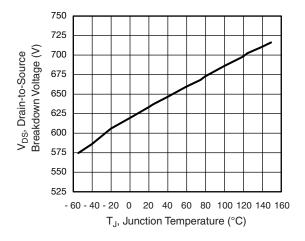


Fig. 11 - Temperature vs. Drain-to-Source Voltage



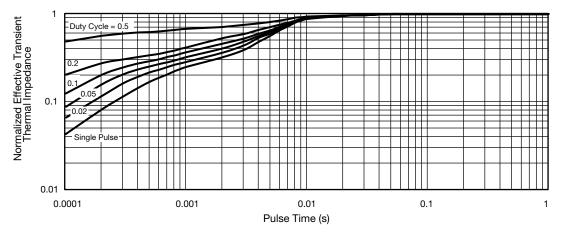


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

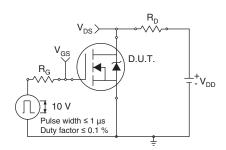


Fig. 13 - Switching Time Test Circuit

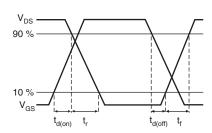


Fig. 14 - Switching Time Waveforms

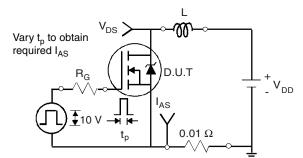


Fig. 15 - Unclamped Inductive Test Circuit

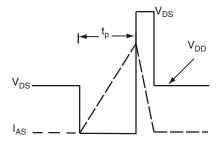


Fig. 16 - Unclamped Inductive Waveforms

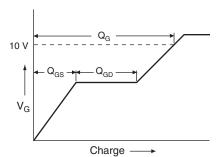


Fig. 17 - Basic Gate Charge Waveform

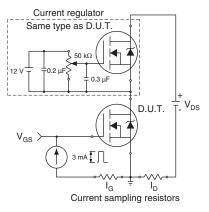
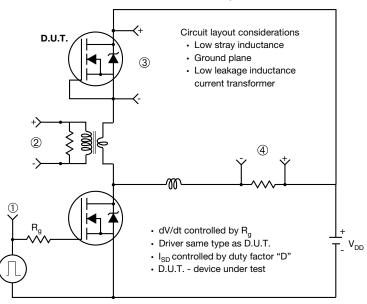


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



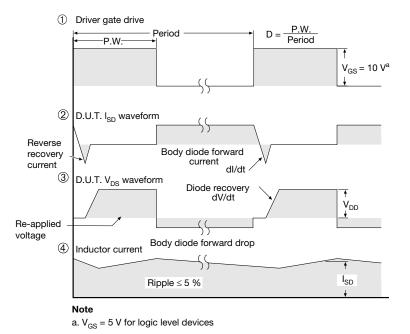


Fig. 19 - For N-Channel

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TO-263AB (HIGH VOLTAGE)







View A - A

	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	4.06	4.83	0.160	0.190
A1	0.00	0.25	0.000	0.010
b	0.51	0.99	0.020	0.039
b1	0.51	0.89	0.020	0.035
b2	1.14	1.78	0.045	0.070
b3	1.14	1.73	0.045	0.068
С	0.38	0.74	0.015	0.029
c1	0.38	0.58	0.015	0.023
c2	1.14	1.65	0.045	0.065
D	8.38	9.65	0.330	0.380

	MILLIMETERS		INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
D1	6.86	-	0.270	-	
Е	9.65	10.67	0.380	0.420	
E1	6.22	-	0.245	i	
е	2.54 BSC		0.100 BSC		
Н	14.61	15.88	0.575	0.625	
L	1.78	2.79	0.070	0.110	
L1	-	1.65	ı	0.066	
L2	-	1.78	-	0.070	
L3	0.25 BSC		0.010 BSC		
L4	4.78	5.28	0.188	0.208	

ECN: S-82110-Rev. A, 15-Sep-08

DWG: 5970

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.
- 4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.

Document Number: 91364 www.vishay.com Revision: 15-Sep-08





RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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